

# GridPix for future experiments

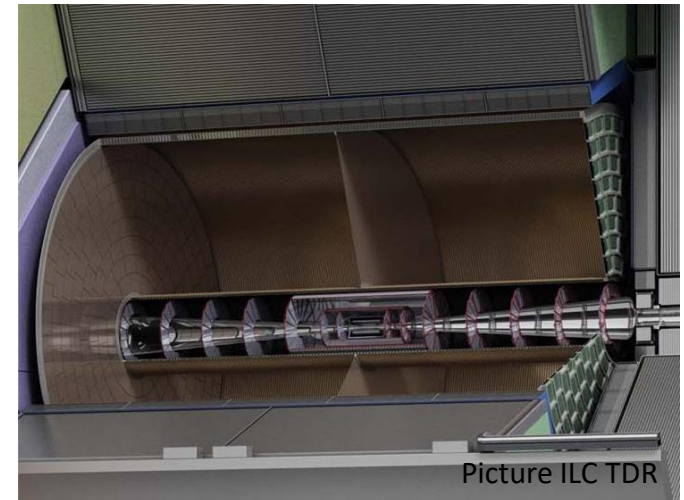
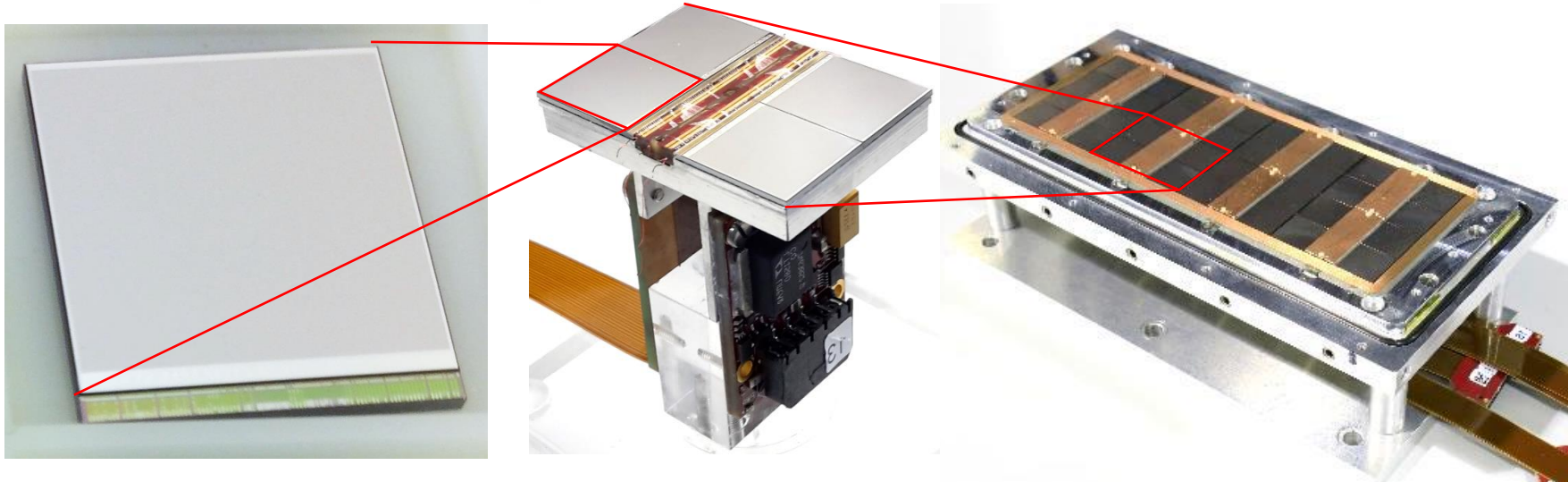
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J. Kaminski, P.M. Kluit, N. van der Kolk, G. Raven, T. Schiffer, J. Timmermans



Topical workshop on New Horizons in Time Projection Chambers, 7 October 2020

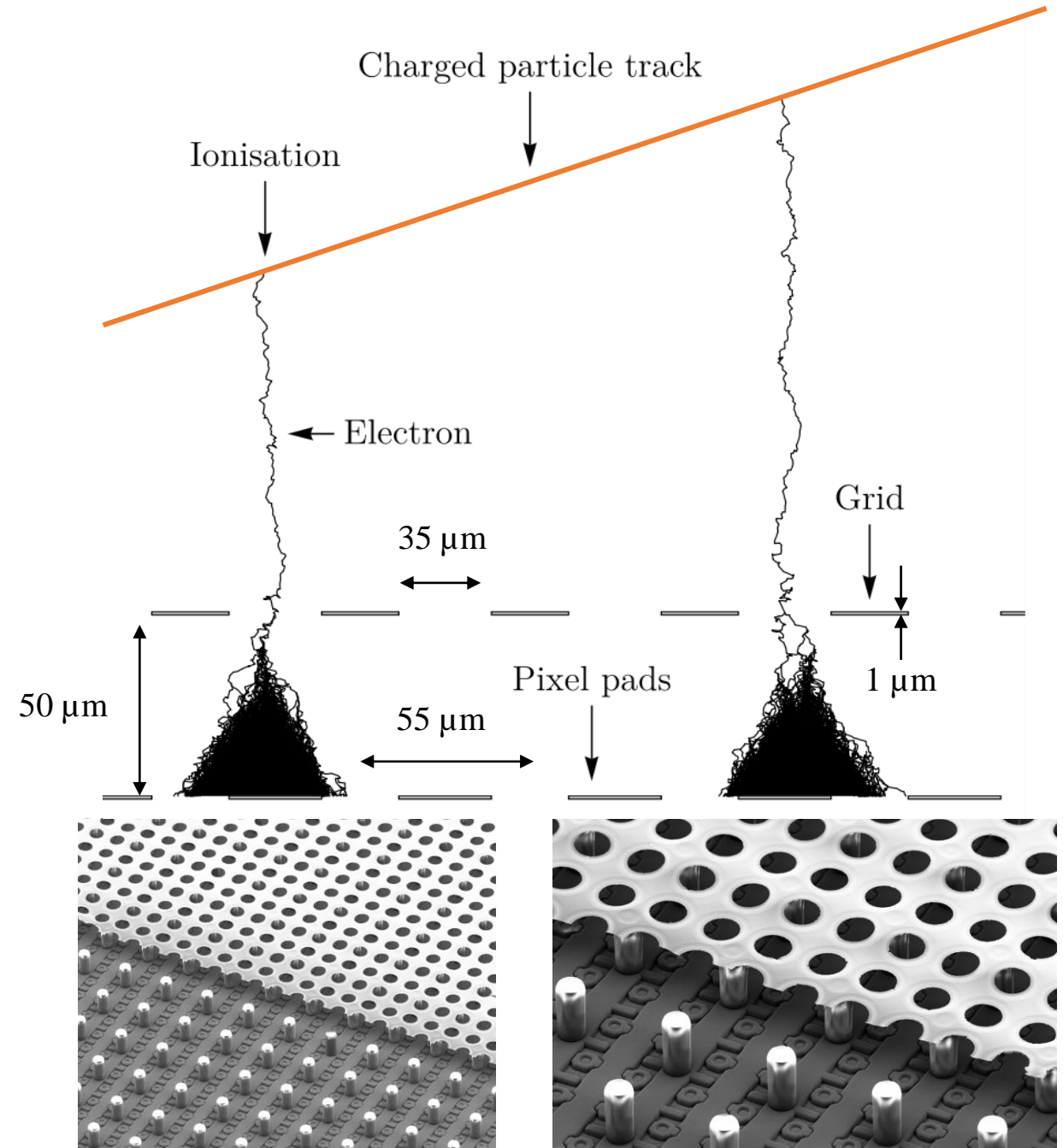
# Introduction and outline

- GridPix is a  $55\text{ }\mu\text{m} \times 55\text{ }\mu\text{m}$  pixel readout for a gaseous TPC
- First Timepix3 based GridPix test beam (2017)
- Quad module performance from test beam (2018)
- Investigations of the 8 quad detector (2020)
- Future applications in a collider experiment
- Future applications in a negative ion TPC



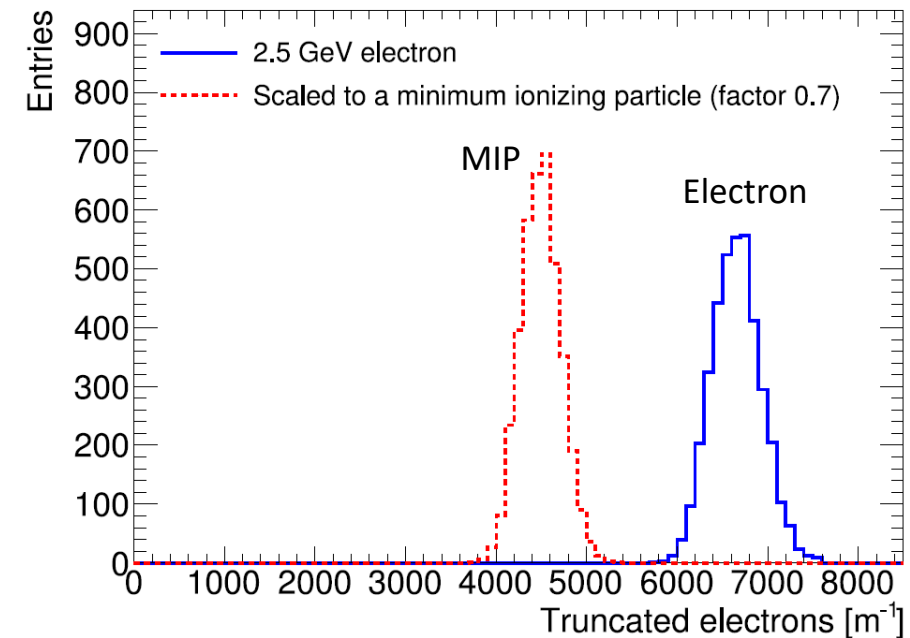
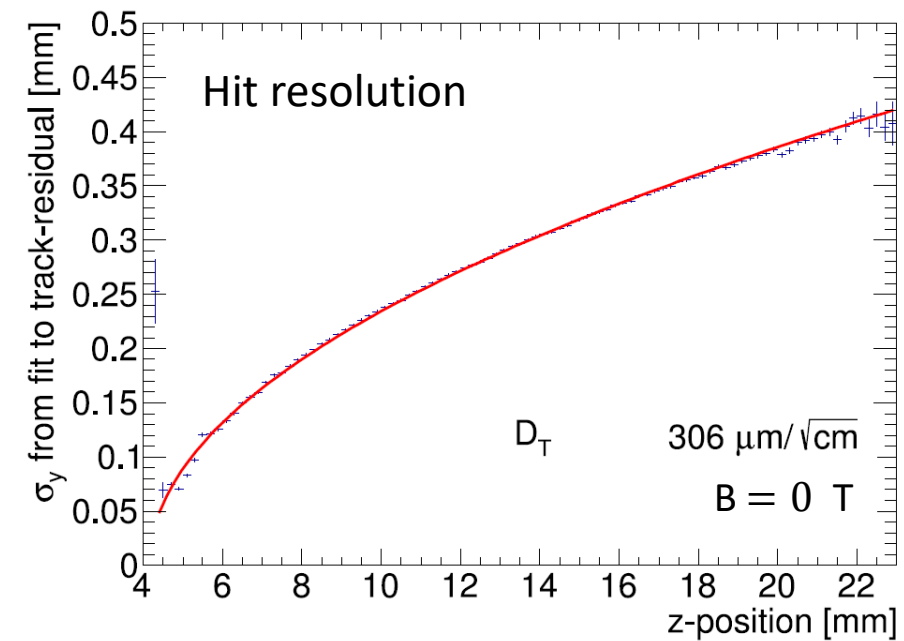
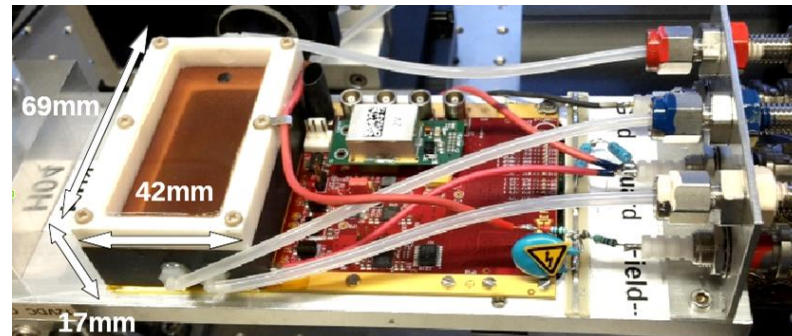
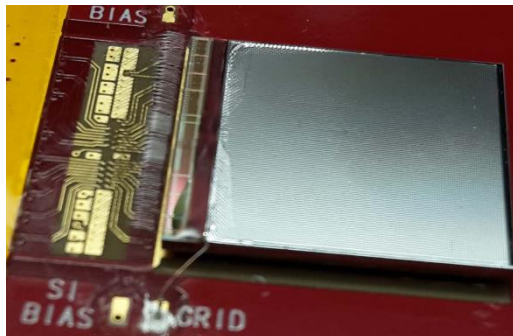
# GridPix technology

- GridPix is a type of micro-pattern gaseous TPC readout
- The GridPix based on a Timepix3 chip
  - $55\text{ }\mu\text{m} \times 55\text{ }\mu\text{m}$  pixels
  - Digital simultaneous registration of Time of Arrival (1.56 ns) and Time over Threshold
  - An aligned Aluminium amplification grid is added by photolithographic postprocessing techniques
- Single ionisation electrons are detected with high efficiency
  - The maximum possible information from a track is acquired
  - $dE/dx$  by cluster counting



# Single chip results (2017)

- A GridPix based on the Timepix3 chip was reliably operated in a test beam setup with 2.5 GeV electrons at ELSA (Bonn)
- T2K gas and  $E_{\text{drift}} = 280 \text{ V/cm}$ ,  $V_{\text{grid}} = -350 \text{ V}$
- The resolution is primarily limited by diffusion
- Systematic uncertainties are small:  $< 10 \text{ } \mu\text{m}$  in plane
- Energy loss resolution ( $dE/dx$ ) by electron counting is 4.1 % per meter

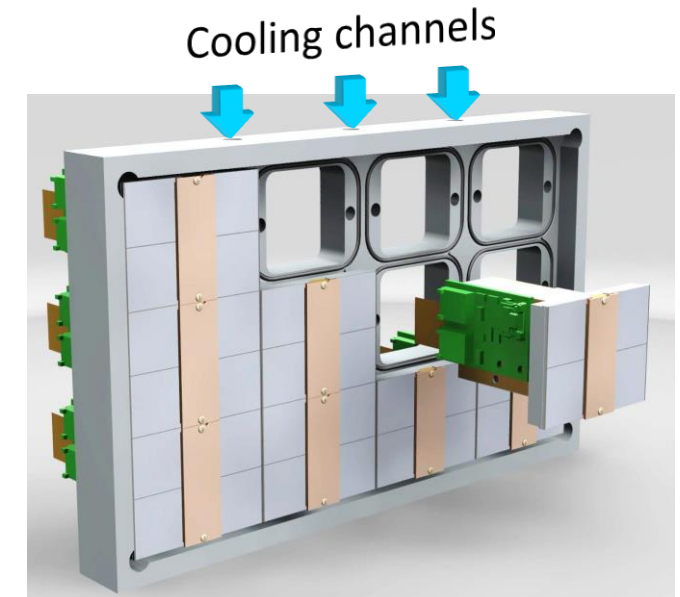
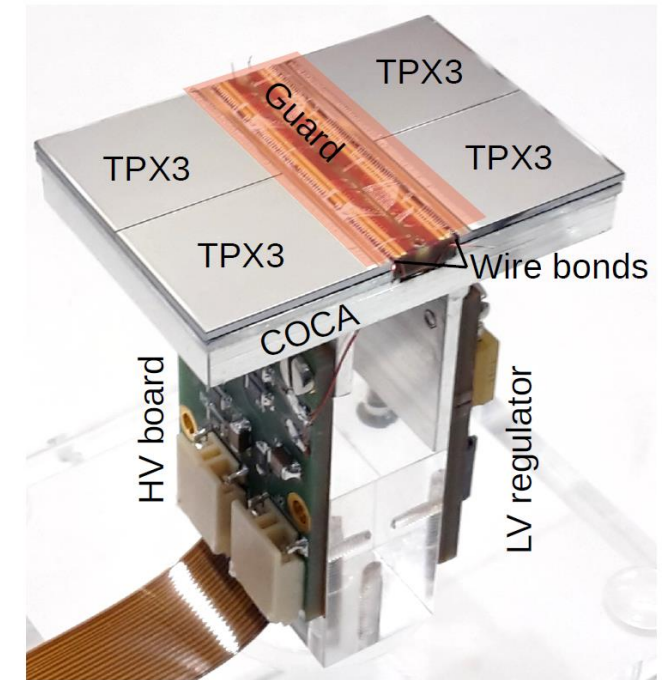


Published paper on this testbeam [doi:10.1016/j.nima.2018.08.012](https://doi.org/10.1016/j.nima.2018.08.012)



# The quad module

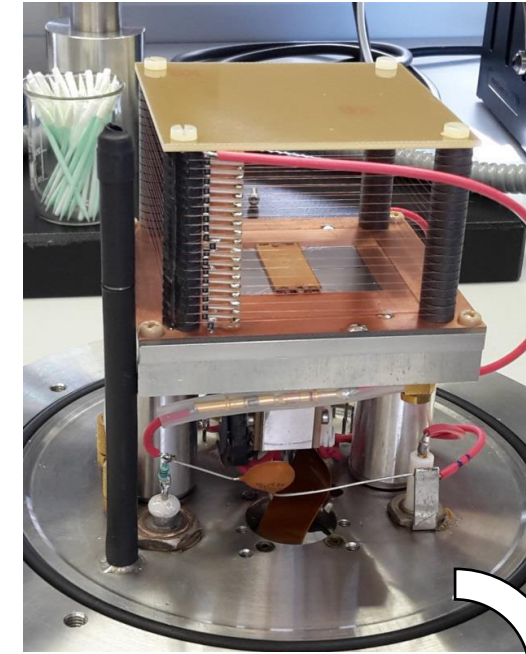
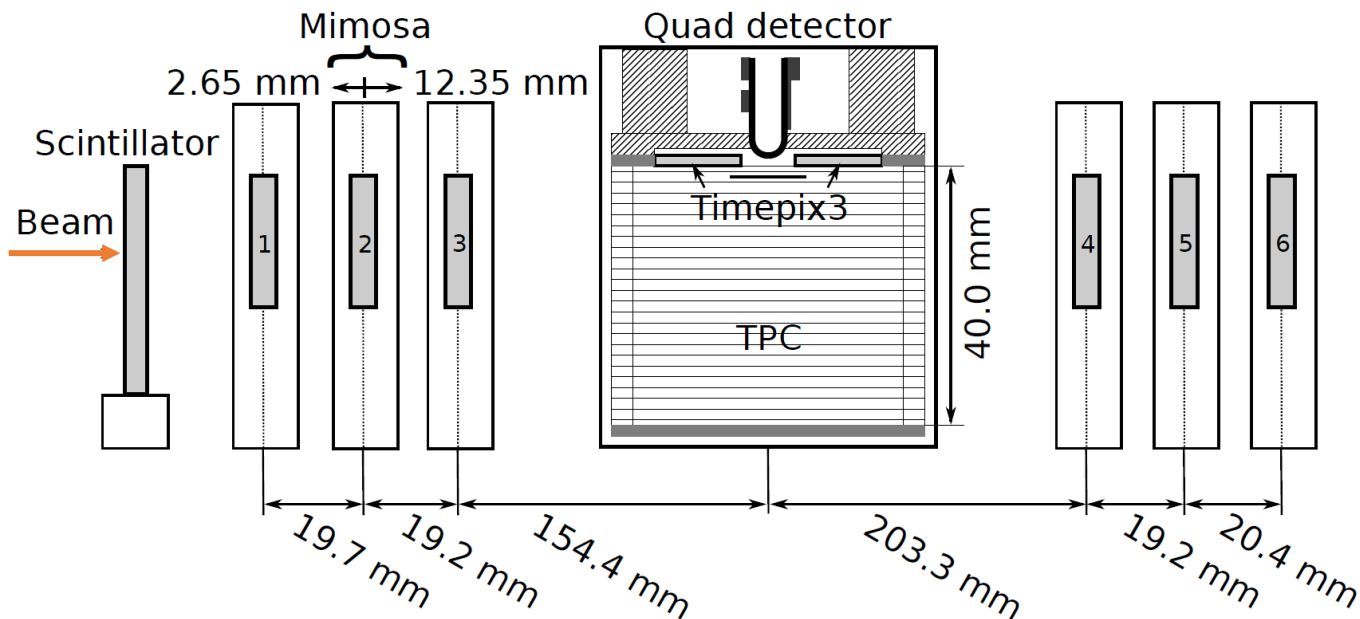
- A four chip module sized 39.6 mm × 28.38 mm
- The quad module has all services under the active area
  - Can be tiled to cover arbitrarily large areas.
- Area for connections IO was minimized
  - Maximises active area ( 68.9% )
- To maintain a homogenous electric field wire bonds are covered by a central guard
- High precision < 20 μm mounting of the chips and guard



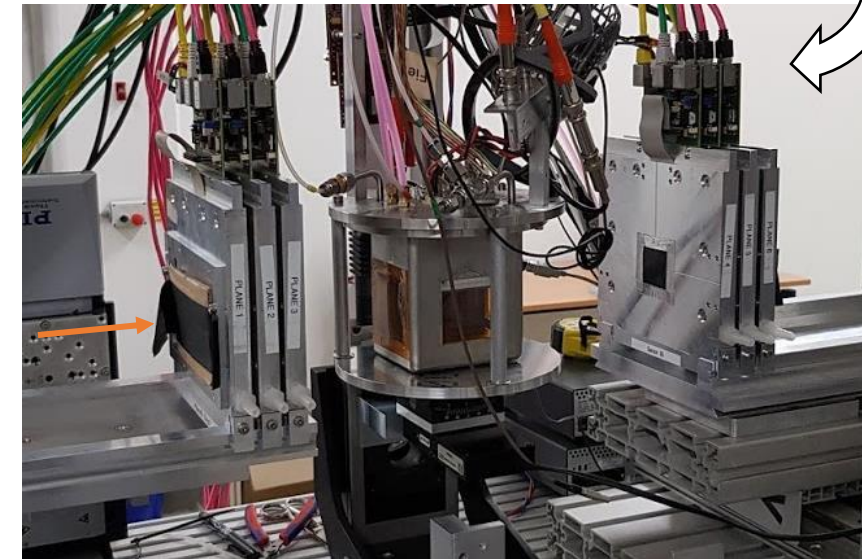
Published paper on quad testbeam: [doi:10.1016/j.nima.2019.163331](https://doi.org/10.1016/j.nima.2019.163331)

# Test beam measurements (2018)

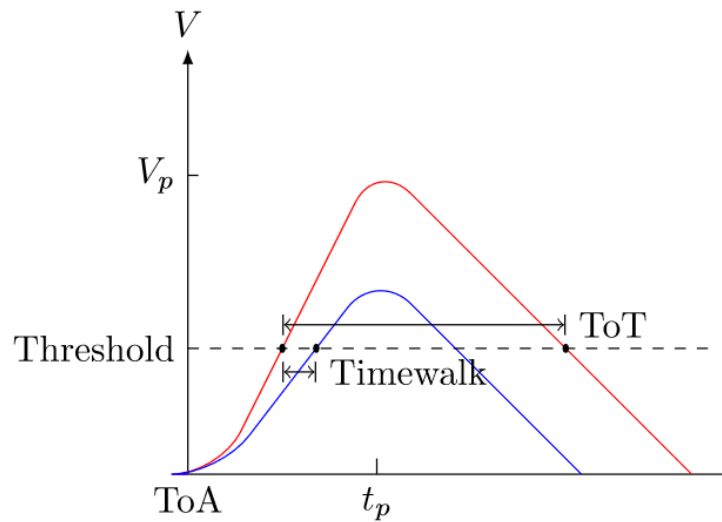
- 2.5 GeV electrons at the ELSA accelerator in Bonn, Germany
- T2K gas with  $E_{\text{drift}} = 400 \text{ V/cm}$ ,  $V_{\text{grid}} = -330 \text{ V}$
- Events are triggered by a scintillating plane
- 6 plane mimosa telescope with  $18.4 \mu\text{m} \times 18.4 \mu\text{m}$  sized pixels



180 °

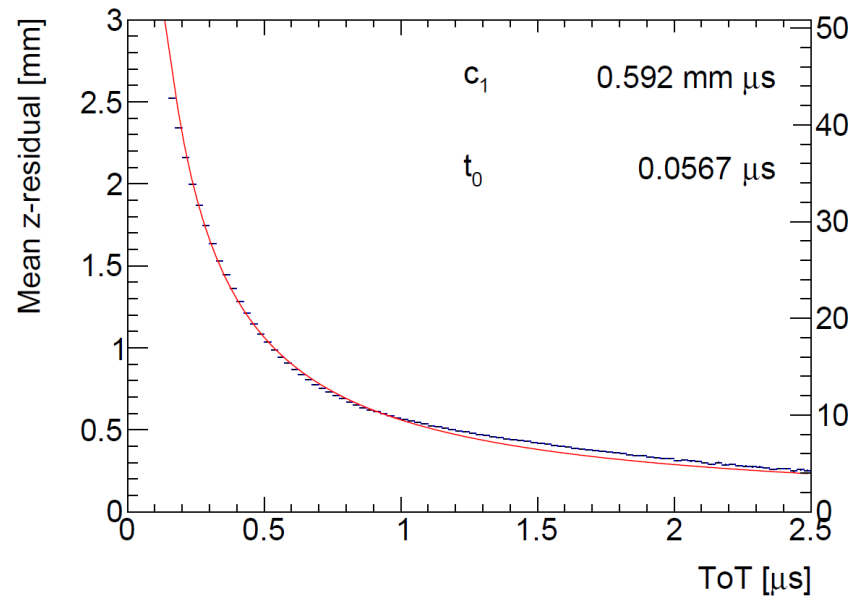


# Time walk correction with the Timepix3



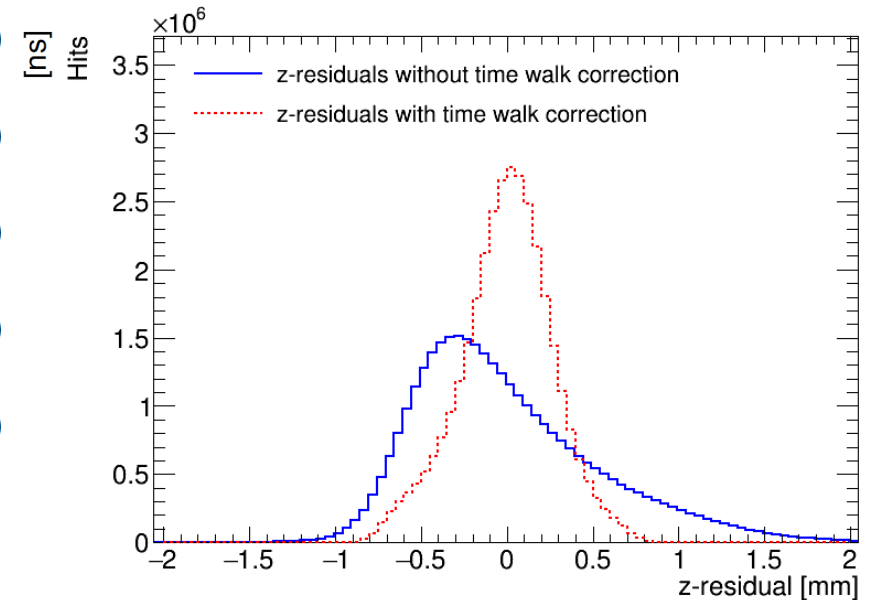
Time walk error: time of arrival depends on signal amplitude

Time walk can be corrected using Time over Threshold (ToT) as a measure for signal strength



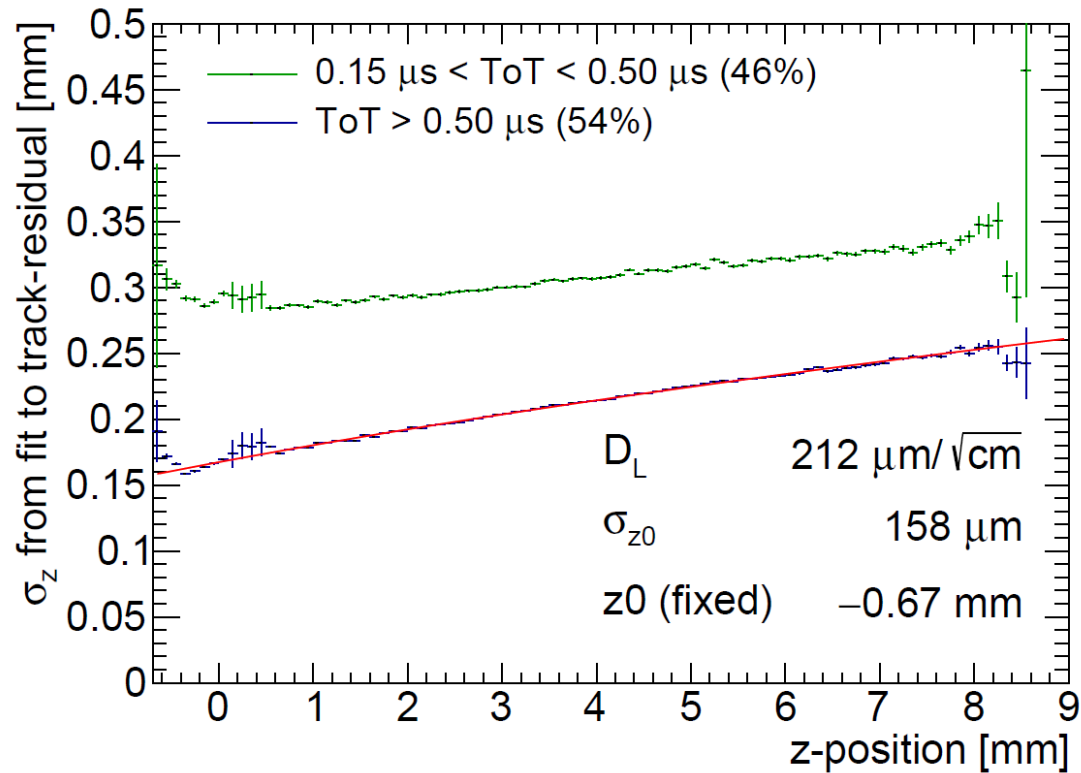
First order correction fitted and applied:

$$\delta z_{\text{timewalk}} = \frac{c_1}{t_{\text{ToT}} + t_0} + z_0$$



Distribution of residuals becomes more Gaussian after the time walk correction

# Hit resolution in the drift direction



Single hit resolution in drift direction

$$\sigma_z^2 = \sigma_{z0}^2 + D_L^2(z - z_0)$$

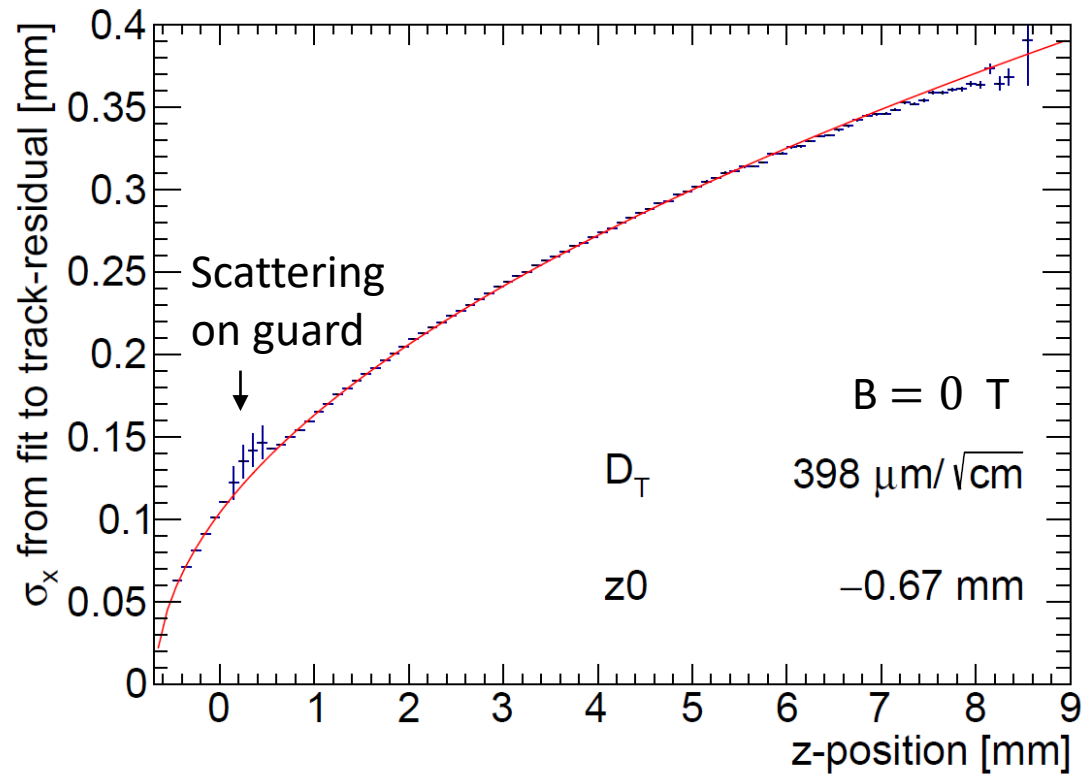
Depends on

- $\sigma_{z0}$  from fit
- Diffusion  $D_L$  from fit

Because of a large time walk error in hits with a low signal strength, an additional ToT cut ( $> 0.50 \mu\text{s}$ ) was imposed



# Hit resolution in the pixel (precision) plane



Single hit resolution in pixel (precision) plane:

$$\sigma_y^2 = \sigma_{y0}^2 + D_T^2(z - z_0)$$

Depends on:

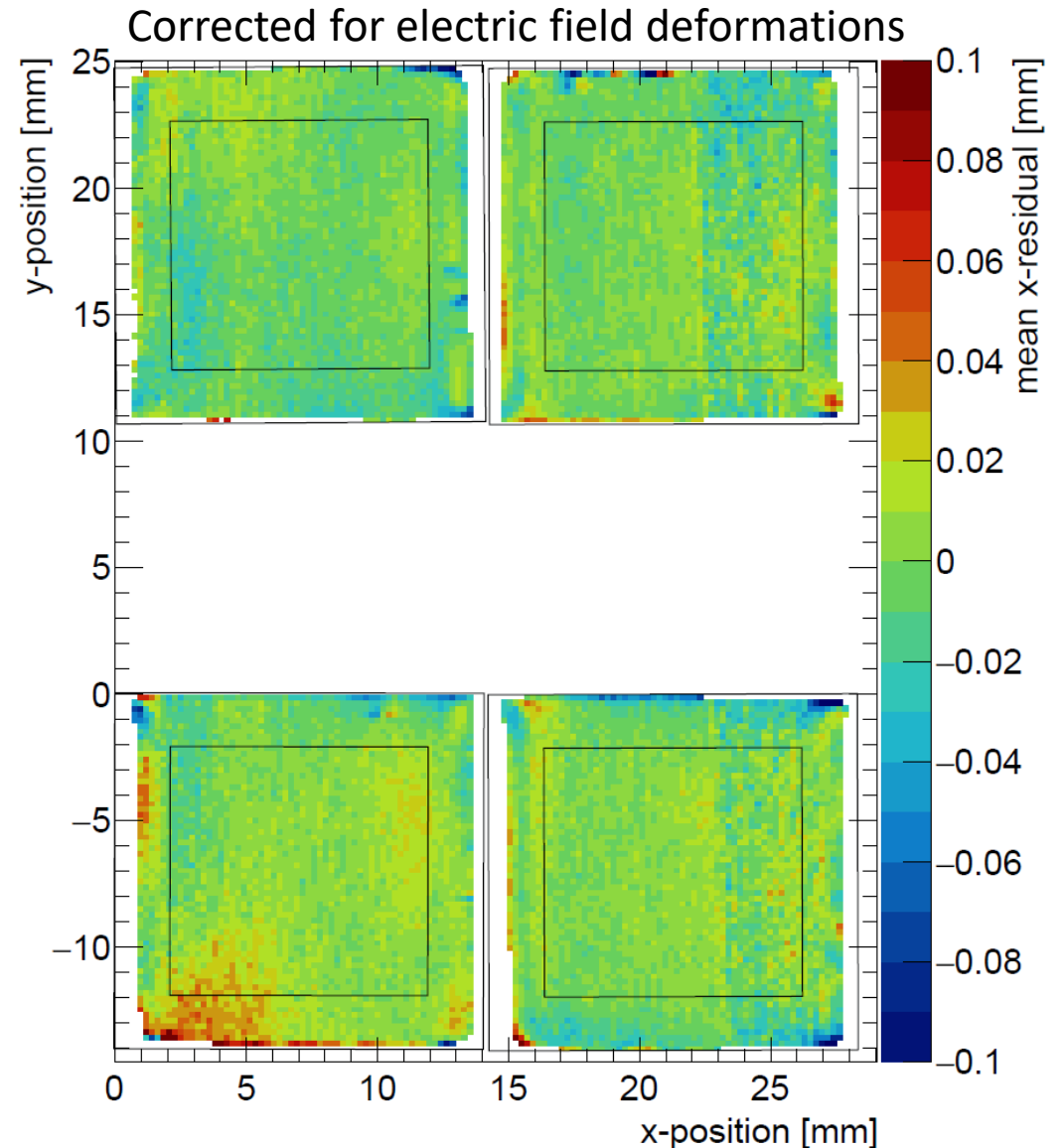
- $\sigma_{y0}$  = pixel size  $55 \text{ } \mu\text{m}/\sqrt{12}$
- Diffusion  $D_T$  from fit

Note that:

- A hit resolution of  $\sim 250 \text{ } \mu\text{m}$  is  $\sim 25 \text{ } \mu\text{m}$  for a 100-hit track ( $\sim 1 \text{ cm}$  track length)
- At  $B = 4 \text{ T}$ , expected  $D_T = 25 \text{ } \mu\text{m}/\sqrt{\text{cm}}$
- At  $B = 2 \text{ T}$ , expected  $D_T = \sim 60 \text{ } \mu\text{m}/\sqrt{\text{cm}}$

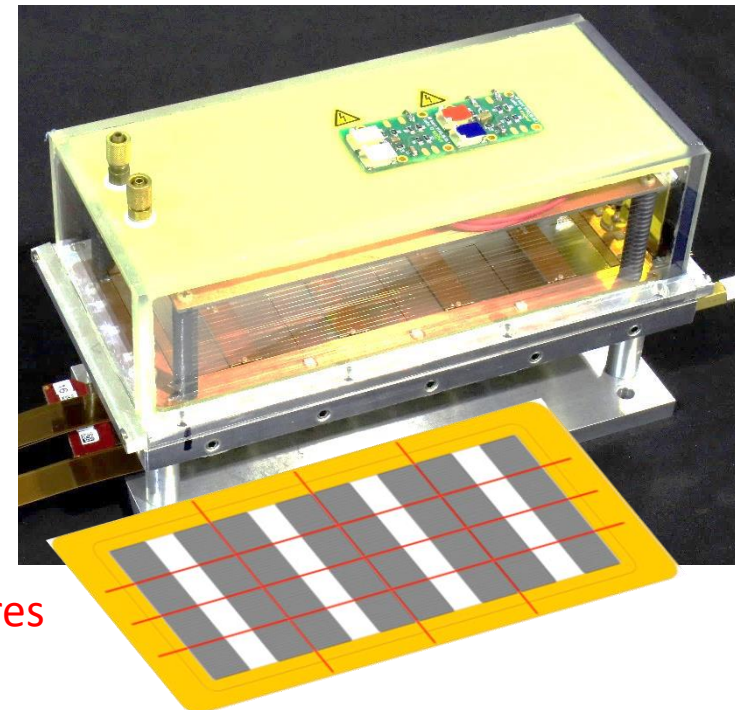
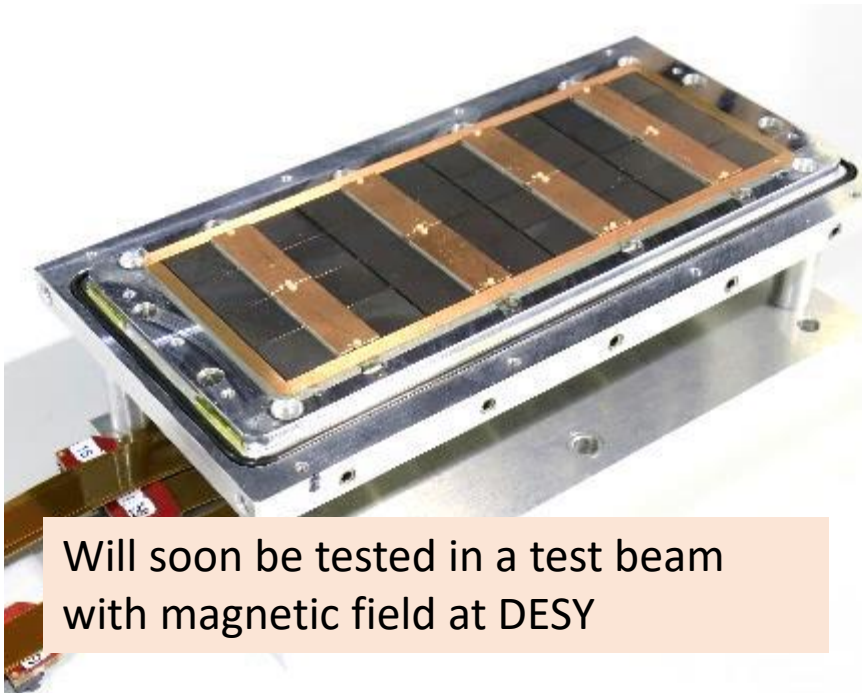
# Deformations in the pixel (precision) plane

- Investigation of systematic deviations over the pixel plane
- Each bin displays mean of residuals from  $4 \times 4$  pixels
- After correction of the residuals for the distortions from the electric field
- The RMS is  $13 \mu\text{m}$  over the whole chip, and  $9 \mu\text{m}$  in the centre (black outline)



# 8 quad module development

- 8 quad test box with (32 chips)
- Simultaneous read out through one SPIDR board using data concentrators
- Field wires added to improve electric field, and reduce deformations



# A TPC at a future collider experiment

A collider experiment benefits from a TPC, because of the minimal material budget, continuous 3D tracking,  $dE/dx$  measurements, and cost-effectiveness

Potential issues at future colliders:

- Ions in the drift chamber from either primary ionisation or backflow cause distortions, which should be limited ( to about  $\mathcal{O}(10\mu\text{m})$  )
  - Backflow ions can be captured by an active gate in front of the readout
- The readout occupancy should be sufficiently low for track finding (typically  $< 10\%$  voxel occupancy)
  - A pixel readout has a greatly reduced occupancy compared to a pad readout



# Prospects for a TPC at a future collider

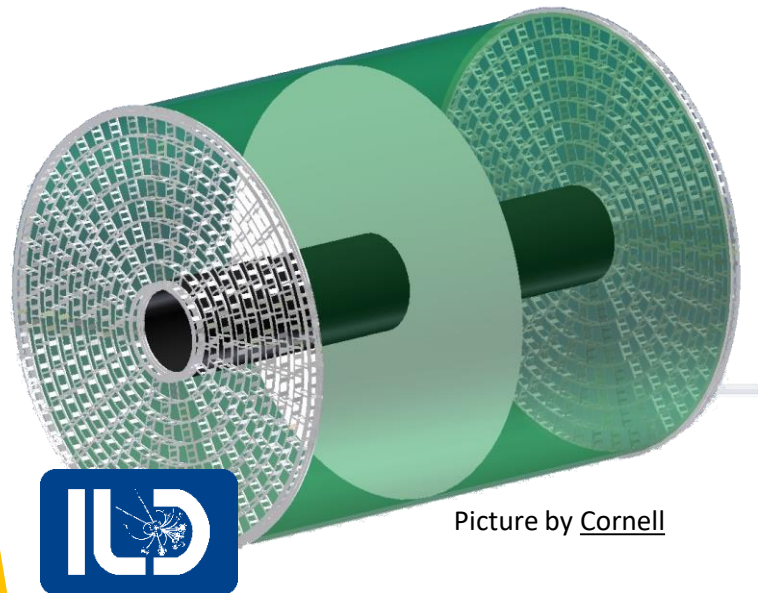
Non-exhaustive list of potential issues with indicative expectations:

Potential issues → Future colliders ↓	Ions in drift chamber		Readout Occupancy
	Primary ions	Backflow ions	
ILC 1 TeV	Acceptable	GEM ion gate	Low (< 1% voxel)
CLIC 3 TeV	Requires investigation	Gating is possible	100% pads (30% voxel)
			40% pixel (lower voxel)
FCC-ee 91 GeV ( $L = 230 \cdot 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$ )	Too high (distortions > 100 $\mu\text{m}$ )	Too high (gating is not possible)	Most likely low
CEPC 91 GeV ( $L = 34 \cdot 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$ )	Acceptable	~25% event loss if gated	Low (< $2 \cdot 10^{-5}$ voxel)
		Other solutions?	

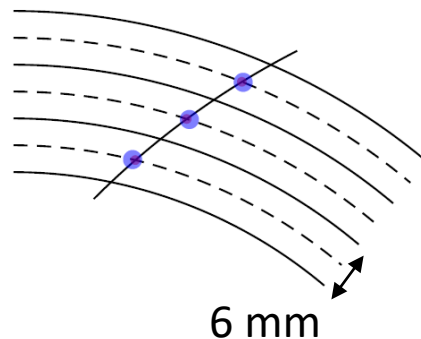
See backup slide for sources

# Simulation of ILD (ILC) TPC with pixel readout

- To study the performance of a large pixelized TPC, the pixel readout was implemented in the full ILD DD4HEP (Geant4) simulation
- Changed the existing TPC pad readout to a pixel readout
- Adapted Kalman filter track reconstruction to pixels

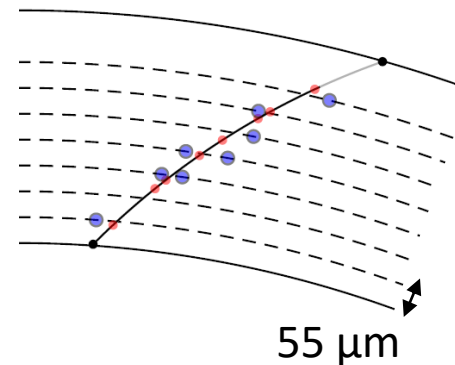


Pads



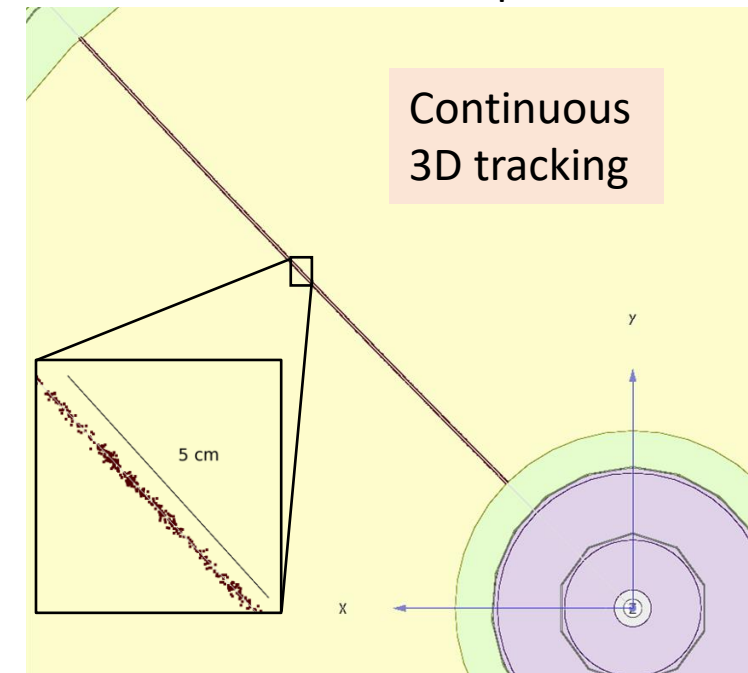
22 electrons / hit  
~200 hits / track

Pixels



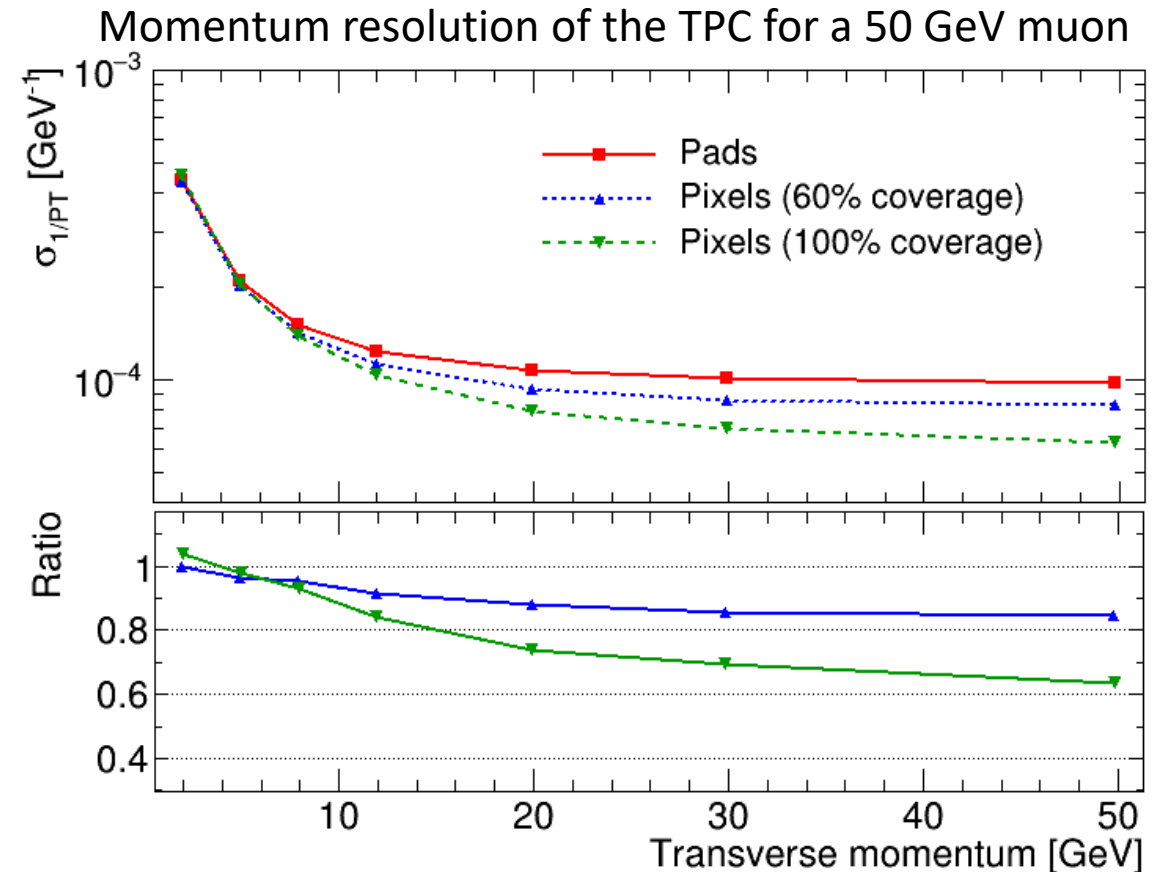
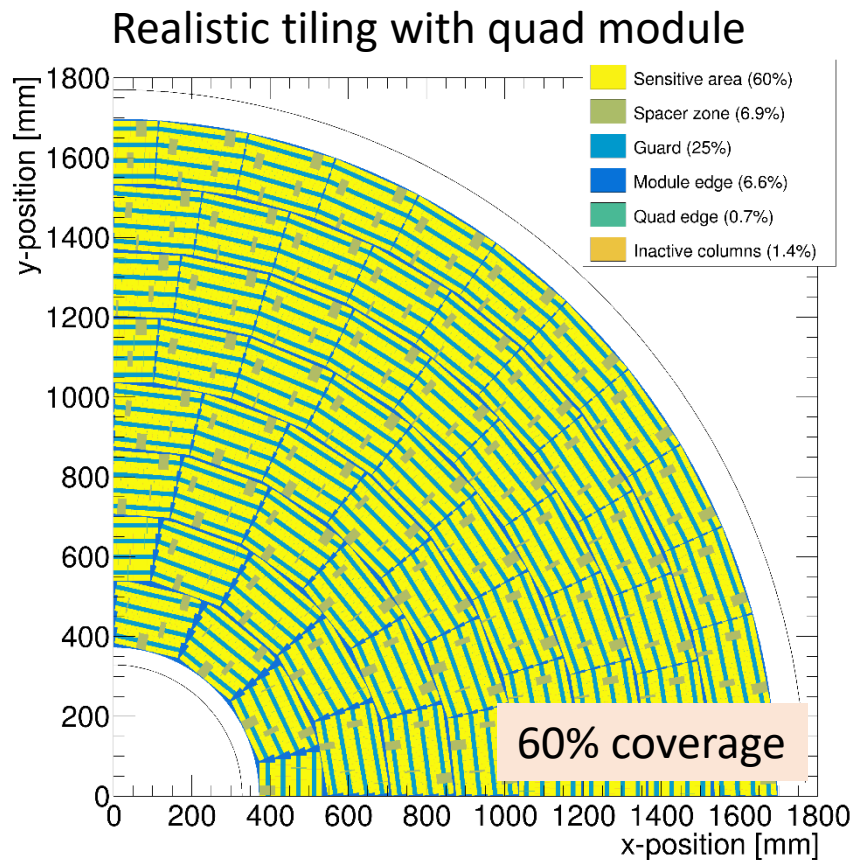
1 electron / hit  
~10 000 hits / track

50 GeV muon track with pixel readout



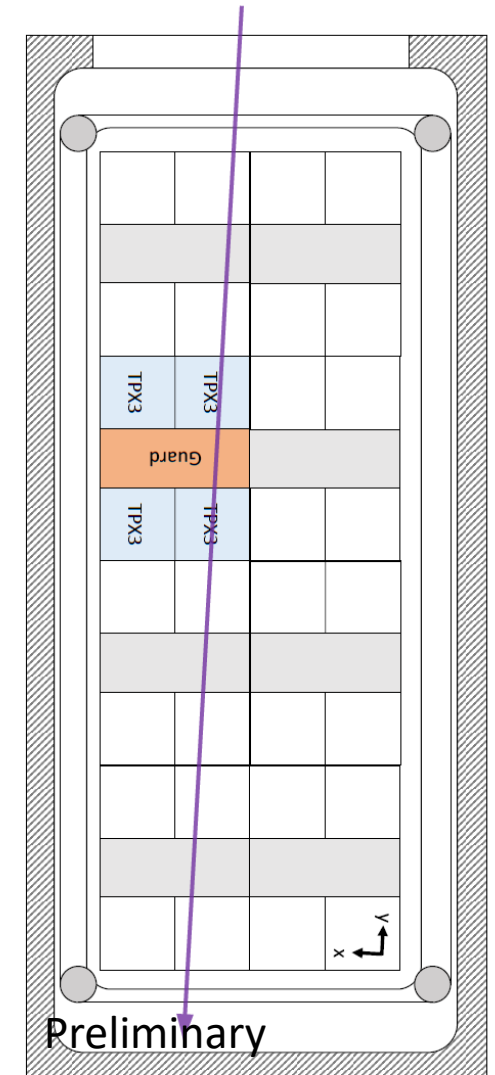
# Performance of a GridPix TPC at ILC

- From full simulation, momentum resolution can be determined
- Momentum resolution is  $\sim 15\%$  better (with realistic 60% coverage)



# A Negative Ion TPC with GridPix readout

- In a negative ion TPC, ionisation electrons are captured shortly after creation by electronegative molecules ( $\text{CS}_2$ ) and drift to the readout plane as negative ions
- In the amplification region, the electron detaches and a normal avalanche occurs
- The negative ion TPC was introduced to reduce diffusion without the need for a magnetic field, [see C. Martoff et al \(2000\)](#)
- The negative ion TPC has been applied to directional dark matter search experiments ([Drift IId](#))
- A single GridPix quad was tested with a UV laser using a  $\text{Ar}/i\text{C}_4\text{H}_{10}/\text{CS}_2$  93.6/5.0/1.4 gas at atmospheric pressure

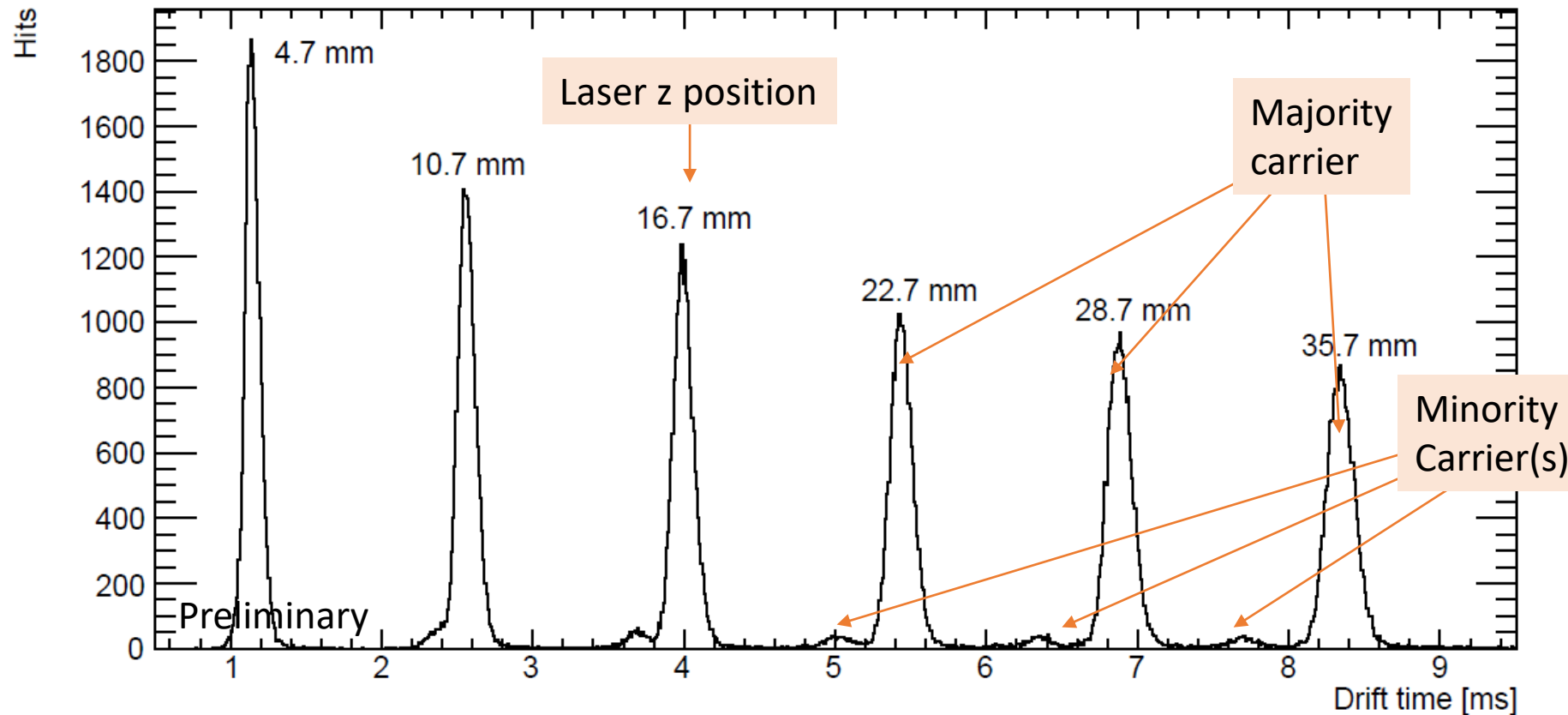


Paper submitted to NIM-A, see also [presentation](#)



# Drift time spectrum

- The difference in arrival time from majority and minority carriers is used to reconstruct the drift distance without a trigger with a precision of 1.3 mm

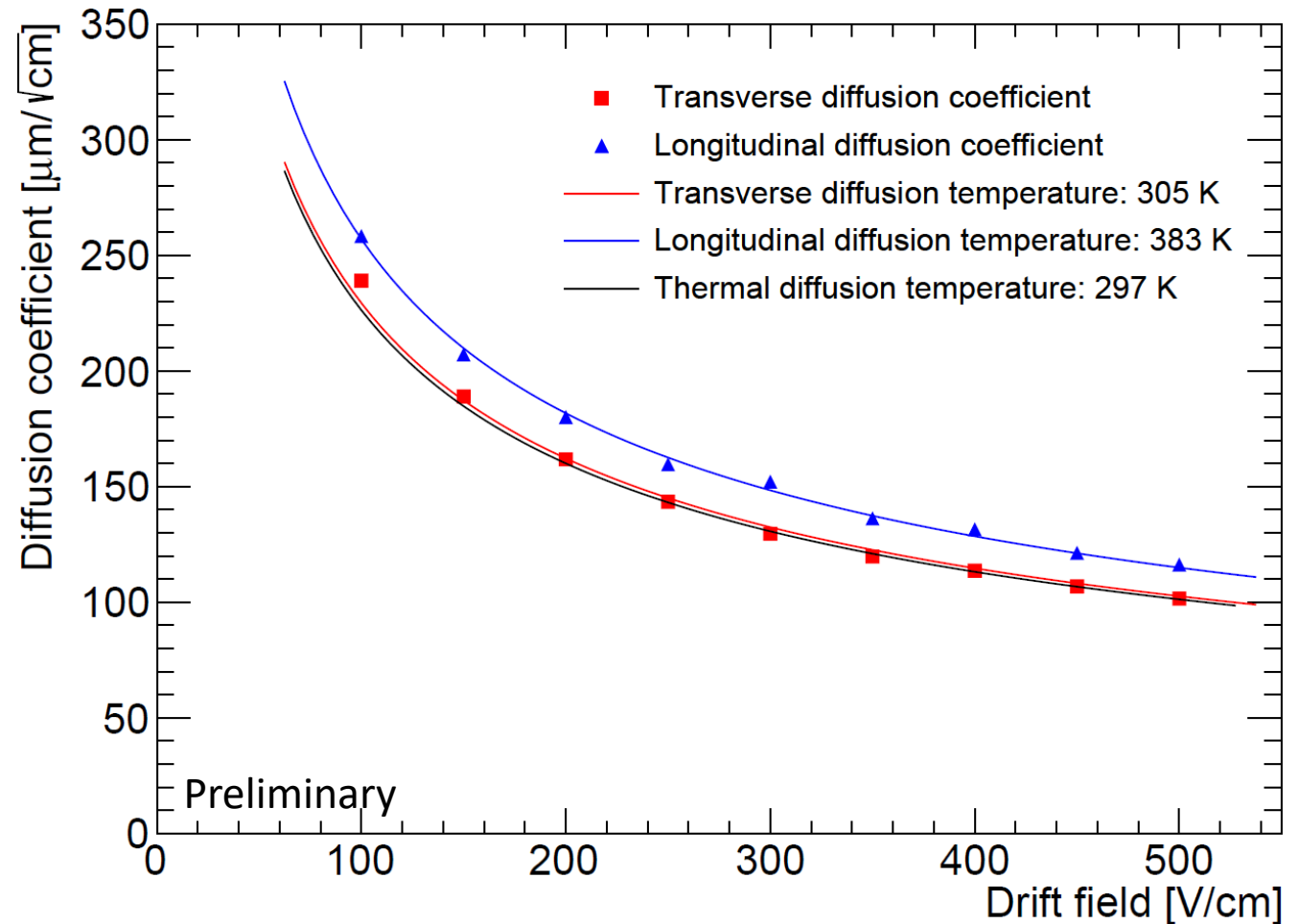


# Diffusion in a negative ion TPC

- The transverse diffusion coefficient is close to the thermal limit

$$D_{\text{thermal}} = \sqrt{\frac{2k_B T}{eE}}$$

- Both diffusion coefficients follow the  $1/\sqrt{E}$  dependence well



# Conclusions

- A quad module with four Timepix3 based GridPix chips has been designed and built
  - The resolution is limited by diffusion
  - Systematic uncertainties are small: 9  $\mu\text{m}$  in the pixel plane
- A 8 quad detector with 32 chips is operational and will be tested in a beam soon
- A TPC with GridPix readout is a good option at the ILC, and possibly at other colliders
- Simulations show an improvement in momentum resolution of a pixel TPC readout over a pad readout of 15 – 35 %
- A negative ion TPC with GridPix readout will allow for detections with a low threshold, and precise determination of the drift distance without a trigger

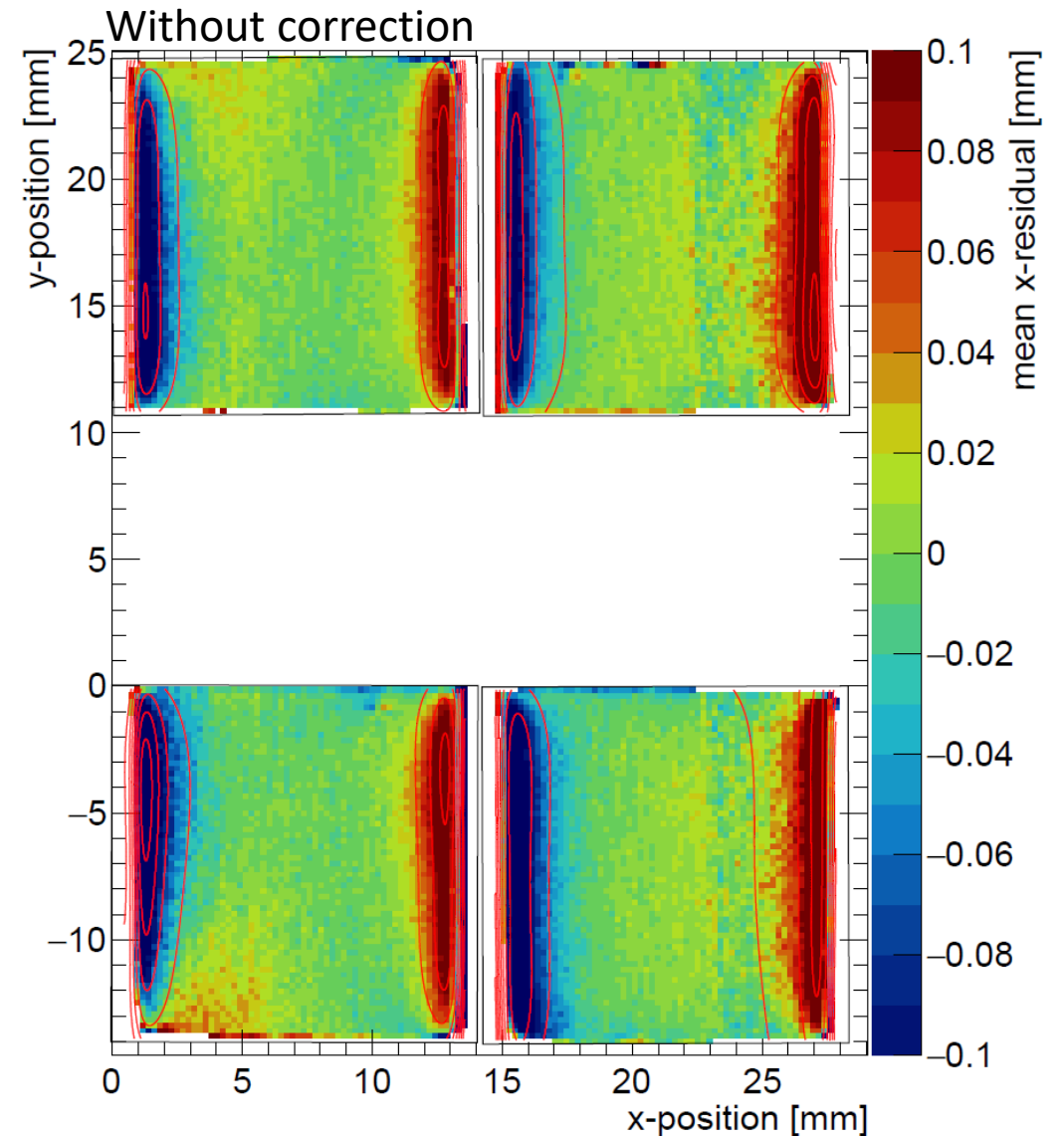
# Backup



# Deformations in the pixel (precision) plane

- Investigation of systematic deviations over the pixel plane
- Each bin displays mean of residuals from  $4 \times 4$  pixels
- Primarily due to electric field distortions
- Correction of deformations with 4 fitted Cauchy functions per chip:

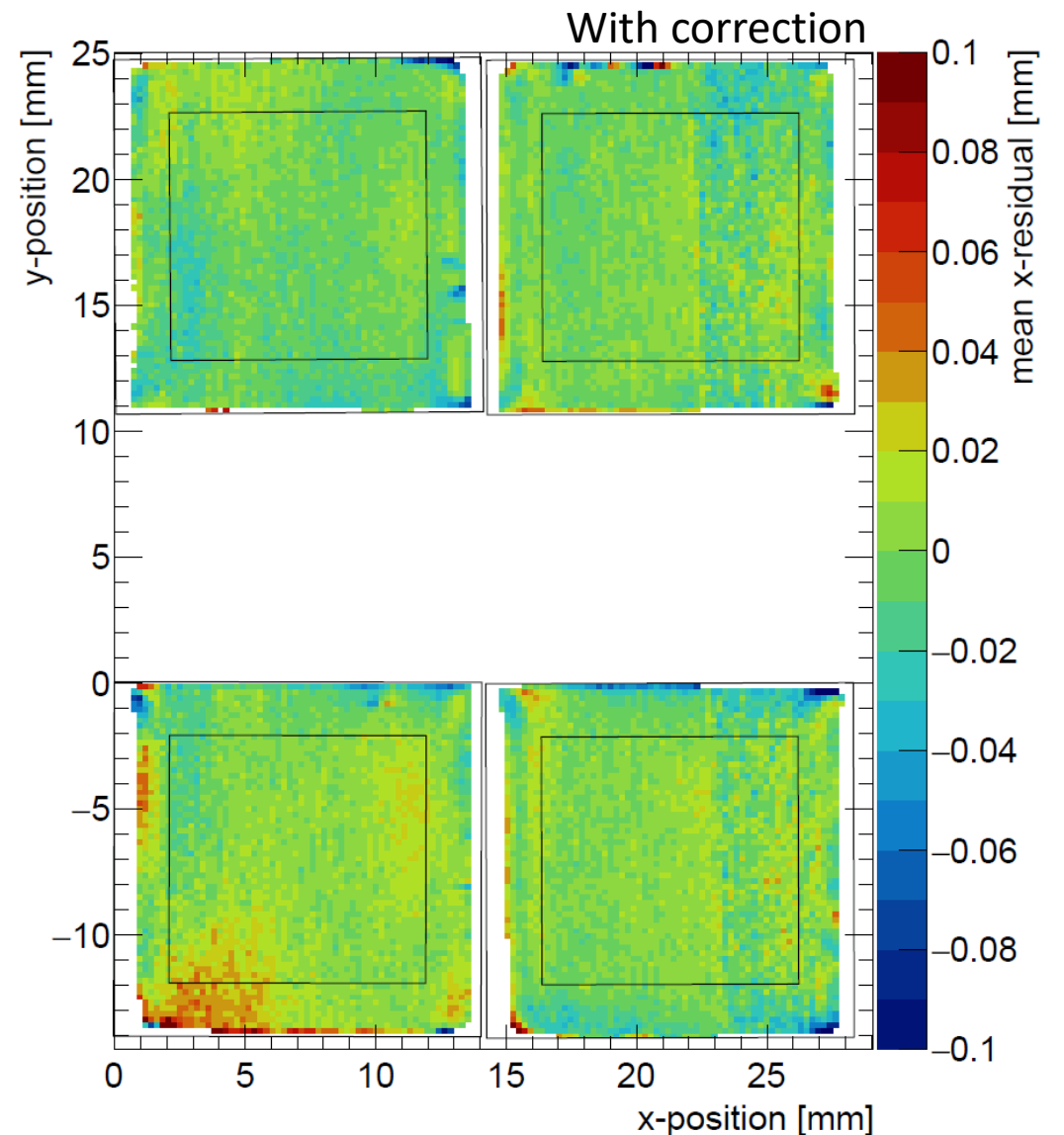
$$\delta x = \sum_{j=0}^4 \left( \frac{1}{\pi} \frac{\gamma_j}{(x - d_j)^2 + \gamma_j^2} \sum_{i=0}^4 (c_{ij} y^i) \right)$$



# Deformations in the pixel (precision) plane

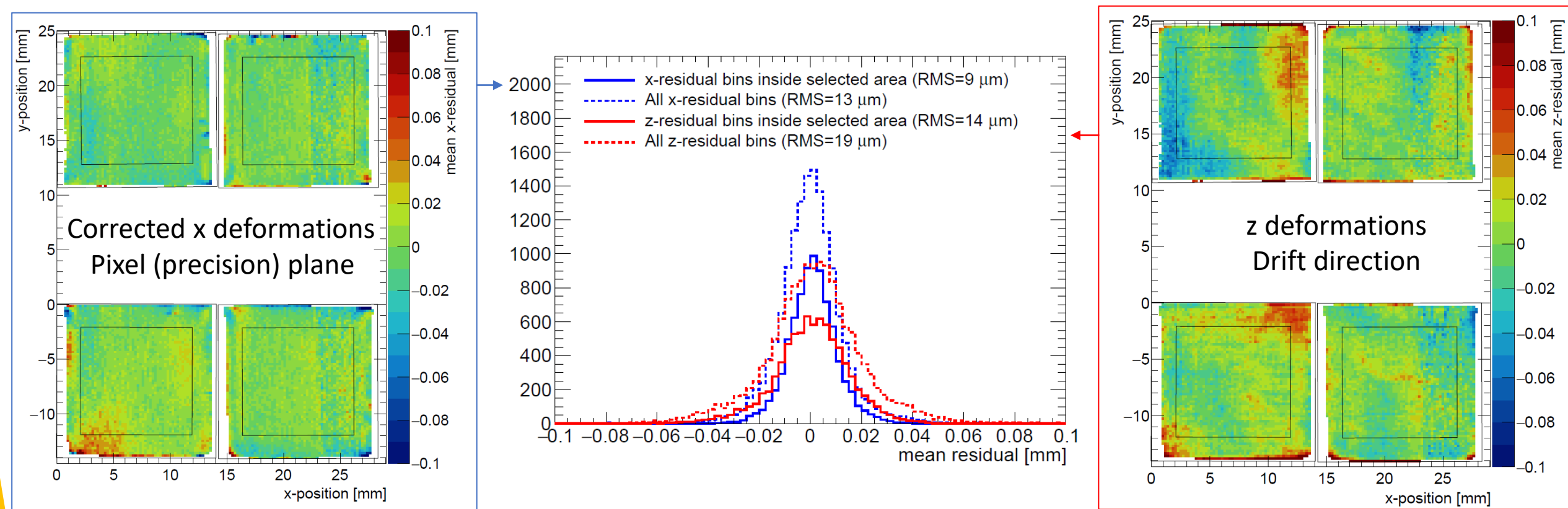
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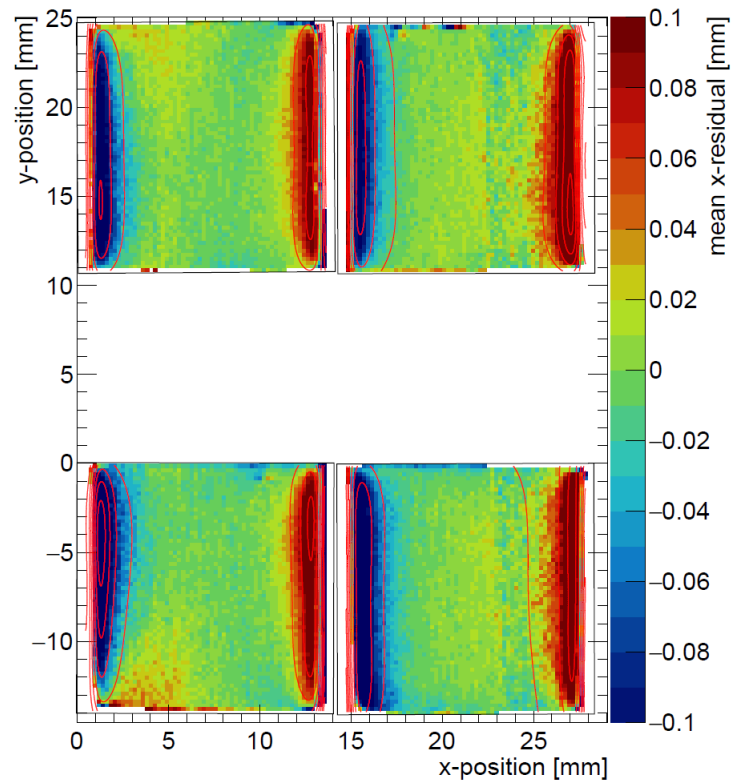
# Deformations in pixel plane and drift direction

- Each bin displays mean of residuals from  $4 \times 4$  pixels
- The RMS in the center of the chip is  $9 \mu\text{m}$  (pixel plane after correction) and  $14 \mu\text{m}$  (drift direction), which indicates small systematic errors

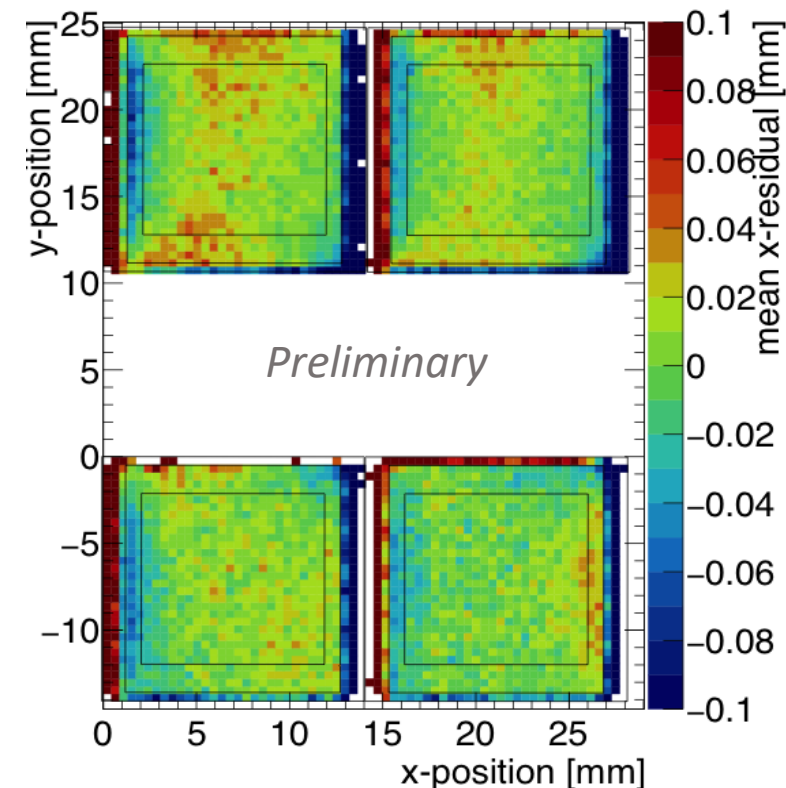


# 8 quad module development

- Laser test indicate a reduction in electric field deformations with field wires
- Early 2020 test beam planned at DESY with 1 T magnetic field



Uncorrected residuals from quad test beam



Uncorrected residuals from laser test with field wires

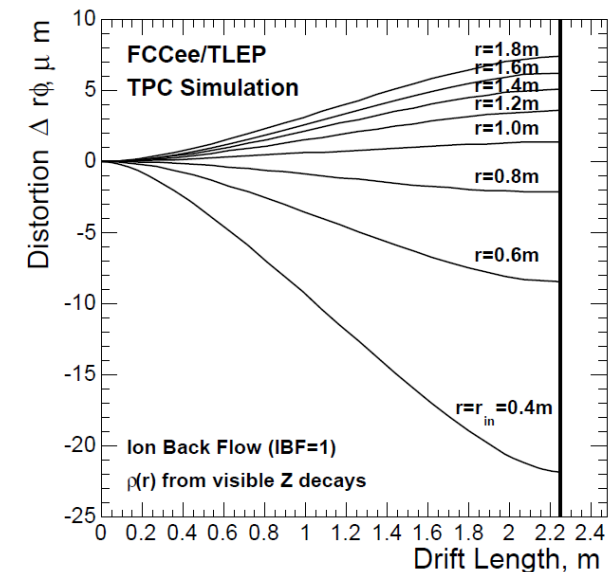
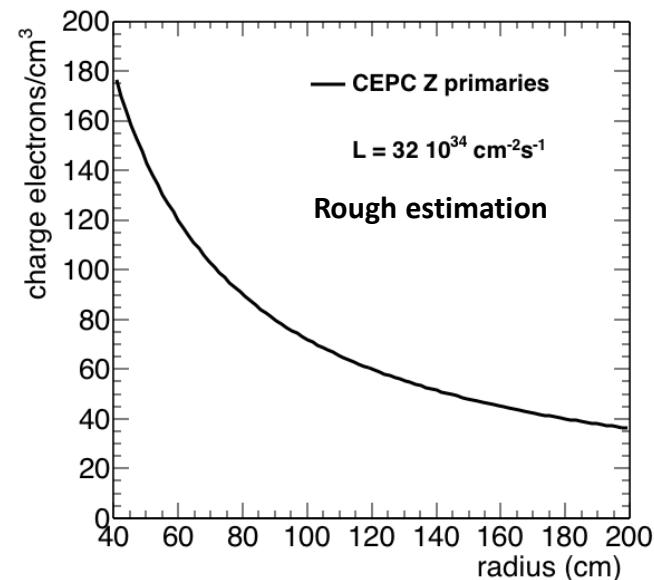


# Ions in circular electron positron collider

- Rough estimations at  $L = 35 \cdot 10^{35} \text{ cm}^{-2} \text{ s}^{-1}$  indicate primary ionisation at a ILC250 level  $\Rightarrow < 5 \text{ } \mu\text{m}$  distortions (This equals  $8 \text{ } \mu\text{m}$  with  $\text{IBF} = 1$ ?) See [Arai Daisuke](#)
- Simulation from CEPC CDR with  $\text{Gain} \times \text{IBF} = 5$  and  $L = 17 \cdot 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$   $\Rightarrow < 40 \text{ } \mu\text{m}$  distortions ( This equals  $16 \text{ } \mu\text{m}$  at  $\text{Gain} \times \text{IBF} = 1$  and  $L = 32 \cdot 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$  )
- FCCee/TLEP studies at  $\text{Gain} \times \text{IBF} = 1$  and  $16.8 \text{ kHz}$  hadronic Zs by [Philippe Schwemling](#)  $\Rightarrow < 22 \text{ } \mu\text{m}$  distortions

## Rough estimation of primary ionisation

- 10 kHz Z event rate
- 500 ms will accumulate 5000 Z events
- 20 tracks / Z event and 10 000 e / track will make  $10^8$  ions in volume
- Volume is  $\sim 4 \cdot 10^7$  resulting in  $25 \text{ e/cm}^3$
- Similar to ILC250 accumulated charge

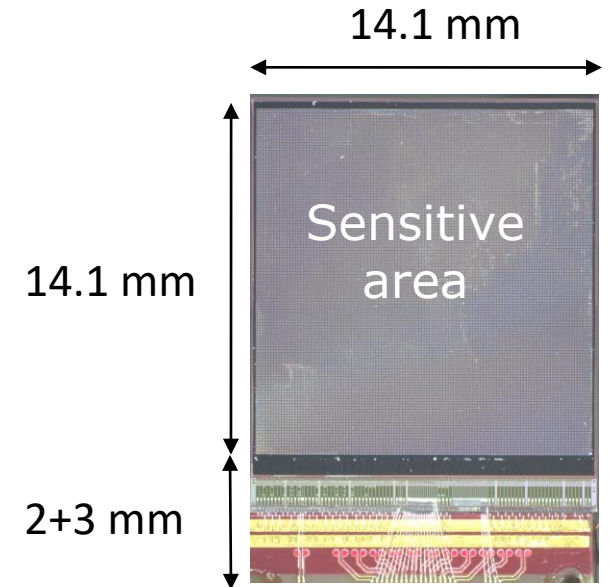


# Ion backflow

- Ion backflow also needs to be controlled as this might lead to large distortions
- Old measurements from GridPix (thesis M. Chefdeville) indicate backflow can be reduced to per mil level
- New measurements are a priority

# Timepix3 pixel chip

- $256 \times 256$  pixels with  $55 \mu\text{m} \times 55 \mu\text{m}$  pitch
- Sensitive area of  $14.1 \text{ mm} \times 14.1 \text{ mm}$
- TDC with 640 MHz clock, resulting in a 1.56 ns time resolution
- Per pixel simultaneous measurement of arrival time (ToA) and signal amplitude (ToT)
- Readout using SPIDR
- Power consumption of 2W depending on hit rate
  - good cooling is important
- Wafer post-processed at IZM Berlin



Timepix3

Header	4 bit
Pixel address	16 bit
Course ToA	14 bit
ToT	10 bit
Fine ToA	4 bit

SPIDR

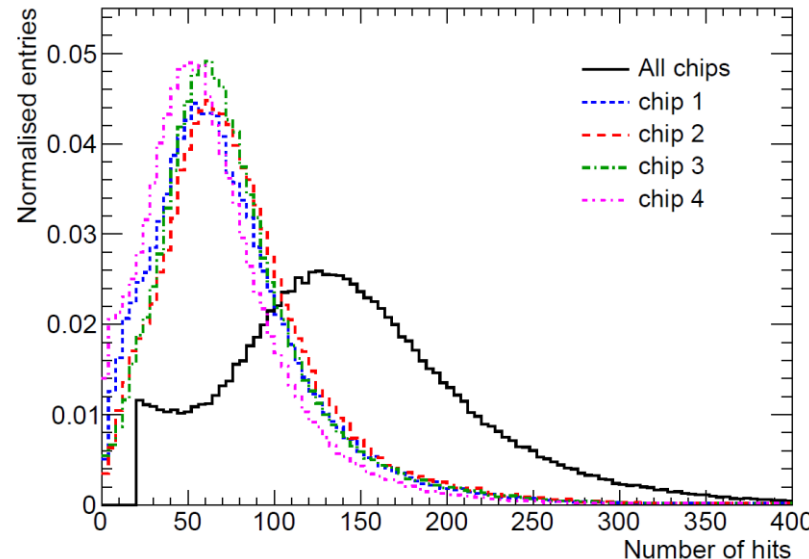
SPIDR timestamp	12 bit
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64 bit data packets

# Run parameters and selections

- Used T2K (Ar:CF<sub>4</sub>:iC<sub>4</sub>H<sub>10</sub> 95:3:2) gas with a water vapor contamination
  - Drift speed 54.6 μm/ns (59.0 μm/ns expected by Magboltz)
- Most probable number of hits per 27.5 mm was 146 (225 expected)
  - This is due to the low effective grid voltage and possibly read out problems
- Use a stringent selection to get clean tracks

Runs duration	10 minutes
Triggers per run	$2.2 \times 10^6$ triggers
$V_{\text{grid}}$	330 V
$E_{\text{drift}}$	400 V/cm
Threshold	$550 e^-$
Temperature	$(300.5 \pm 0.13)$ K
Pressure	$(1011 \pm 0.16)$ mbar
Oxygen concentration	814 ppm
Water vapor concentration	6000 ppm



Telescope
Number of planes hits $\geq 5$
Reject outliers ( $r_{x,z} < 50 \mu\text{m}$ )
Slope difference between sets of planes $< 1 \text{ mrad}$
GridPix hit selection
$-500 \text{ ns} < t_{\text{hit}} - t_{\text{trigger}} < 500 \text{ ns}$
Hit ToT $> 0.15 \mu\text{s}$
Reject outliers ( $r_x < 1.5 \text{ mm}, r_z < 2 \text{ mm}$ )
Reject outliers ( $r_x < 2\sigma_x, r_z < 3\sigma_z$ )
Event Selection
$N_{\text{hits}} \geq 20$
$(N_{r_x < 1.5 \text{ mm}} / N_{r_x < 5 \text{ mm}}) > 0.8$
$ x_{\text{Timepix}} - x_{\text{telescope}}  < 0.3 \text{ mm}$
$ z_{\text{Timepix}} - z_{\text{telescope}}  < 0.3 \text{ mm}$

# Resolution of quad module

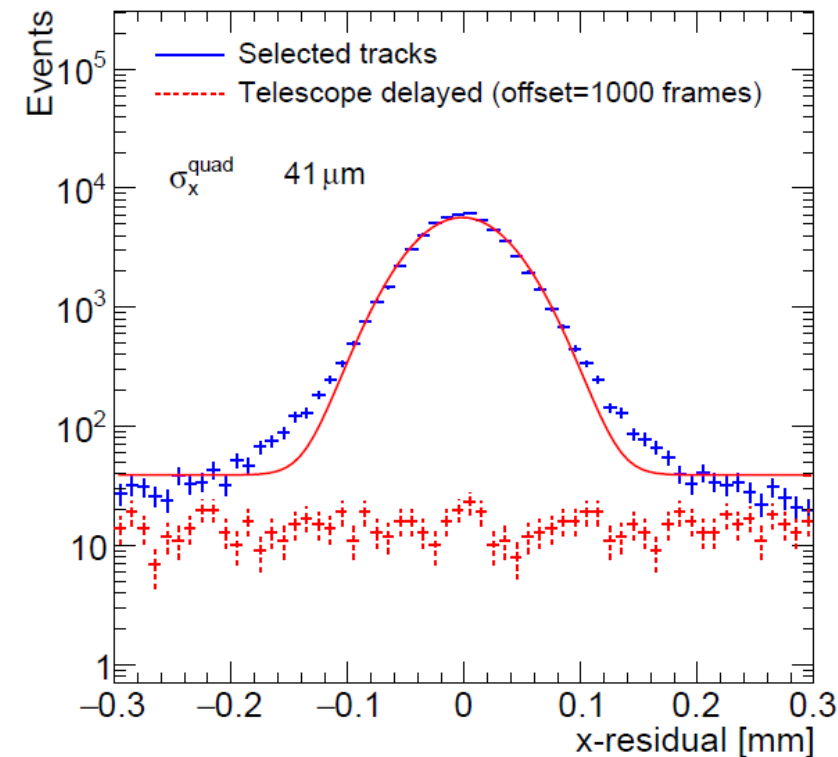
Determine overall accuracy of a track position measurement by comparing the quad track with the telescope track

- Subtract a background of unrelated tracks

Error contributions:

- Statistical error using hit resolution
- Systematic errors from RMS in pixel plane and drift direction
- Multiple scattering contribution from simple Monte Carlo simulation

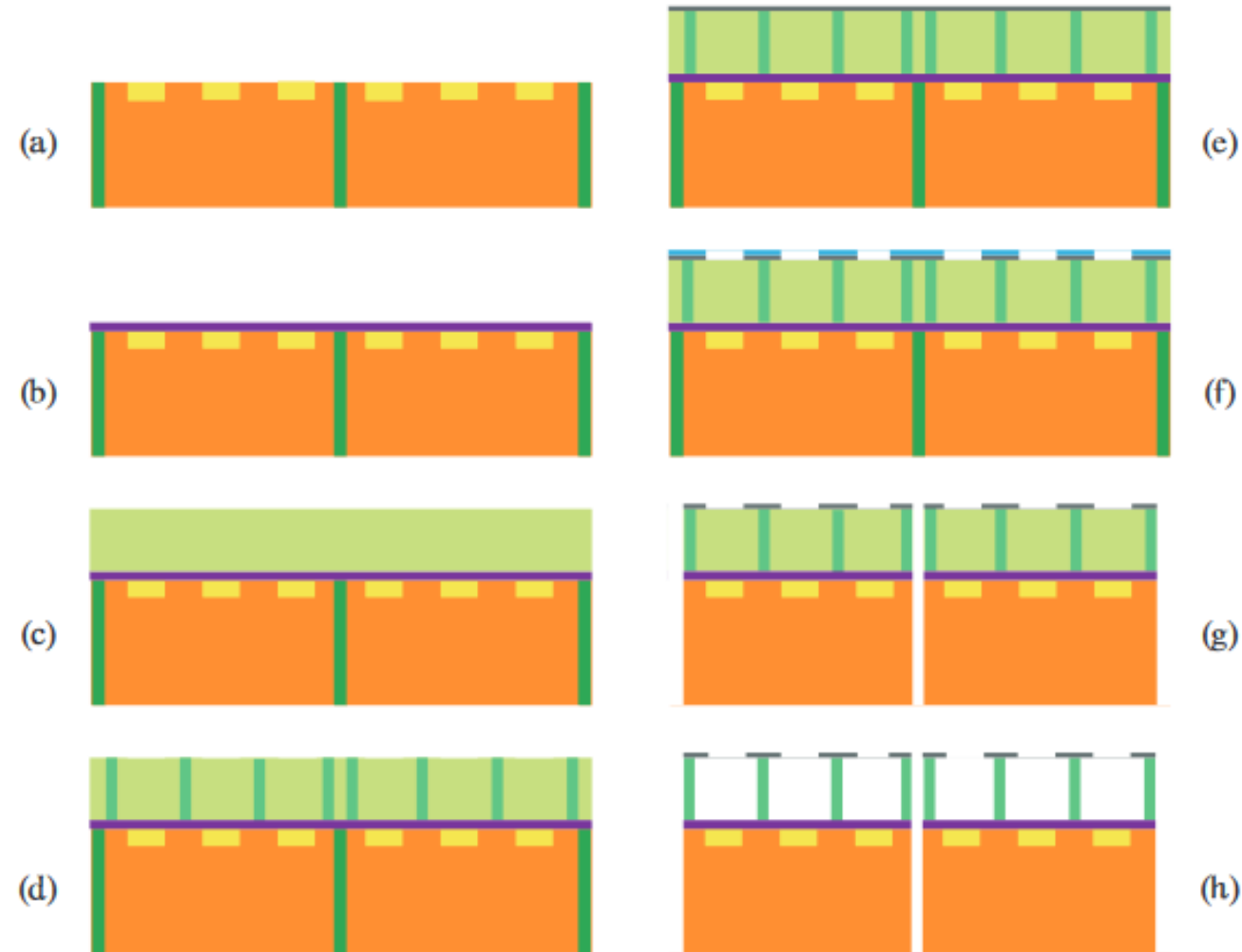
In the end, an unidentified contribution remains



Observed standard deviation	41 $\mu\text{m}$
Statistical errors	25 $\mu\text{m}$
Systematic errors in the pixel plane and drift direction	19 $\mu\text{m}$
Multiple scattering	22 $\mu\text{m}$
Unidentified systematic error	14 $\mu\text{m}$

# Production of GridPixes

- a) Cleaning
- b) Deposition of Protection layer
- c) SU-8 covering
- d) Exposure with mask
- e) Aluminium layer is deposited
- f) Another layer of photoresist is applied, exposer with a mask creates a hole pattern, and the holes are chemically etched
- g) The wafer is diced
- h) The unexposed SU-8 is resolved



Thesis Stergios Tsigaridas, *Next Generation GridPix*



# Prospects for TPC at a future collider

Potential issues → Future colliders ↓	Ions in drift chamber		Readout Occupancy
	Primary ions	Backflow ions	
ILC 1 TeV	<u>Acceptable</u>	<u>GEM ion gate</u>	<u>Low (&lt; 1% voxel)</u>
CLIC 3 TeV	Requires investigation	Gating is possible, based on bunch spacing	<u>100% pads (30% voxel)</u>
			<u>40% pixel (lower voxel)</u>
FCC-ee 91 GeV ( $230 \cdot 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$ )	<u>Too high (<math>10 \times</math> ILC and distortions <math>&gt; 100 \mu\text{m}</math>)</u>	Gating not possible, based on event rate	Most likely low, based on CEPC extrapolations
CEPC 91 GeV ( $34 \cdot 10^{34} \text{ cm}^{-2} \text{ s}^{-1}$ )	<u>Acceptable</u>	<u>~25% event loss if gated</u>	<u>Low (&lt; <math>2 \cdot 10^{-5}</math> voxel)</u>
		<u>Other solutions?</u>	

Some entries in the table are linked to the source

# Motivation for a pixelised TPC

- Improved  $dE/dx$  by cluster counting
- Improved measurement of low angle tracks
- Improved double track separation
- Much reduced hodoscope effect
- Lower occupancy in high rate environments
- Fully digital read out